

Dual N-Channel Enhancement Mode Field Effect Transistor

NDS9945

General Description

SO-8 N-Channel Enhancement Mode Power Field Effect Transistors are Produced using **onsemi**'s proprietary, high cell density, DMOS technology. This very high density process is especially tailored to provide superior switching performance and minimize on-state resistance. These devices are particularly suited for low voltage applications such as disk drive motor control, battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

Features

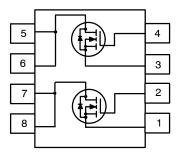
- 3.5 A, 60 V
 - $R_{DS(on)} = 0.100 \Omega @ V_{GS} = 10 V$
 - $R_{DS(on)} = 0.200 \Omega @ V_{GS} = 4.5 V$
- High Density Cell Design for Extremely Low R_{DS(ON)}
- High Power and Current Handling Capability in a Widely used surface mount package
- Dual MOSFET in surface mount package
- This is a Pb-Free and Halide Free Device

ABSOLUTE MAXIMUM RATINGS T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	60	V
V _{GSS}	Gate-Source Voltage	±20	V
I _D	Drain Current - Continuous (Note 1a) - Pulsed	3.5 10	А
P _D	Power Dissipation for Dual Operation	2	W
	Power Dissipation for Single	1.6	
	Operation (Note 1a) (Note 1b) (Note 1c)	1	
		0.9	
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

SOIC-8 CASE 751



MARKING DIAGRAM

&Z&2&K NDS 9945

&Z = Assembly Plant Code
&2 = Numeric Date Code
&K = 2-Digit Lot Code
9945 = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping [†]
NDS9945	SOIC-8 (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	78	°C/W
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case (Note 1)	40	°C/W

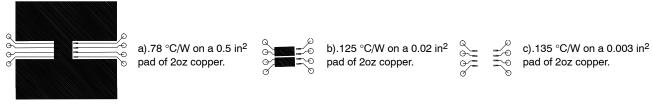
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ELECTRICAL CHARACTERISTICS T_A = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Charac	cteristics	•				
BV _{DSS}	Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V, } I_D = -10 \mu\text{A}$	60	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = -250 μ A, Referenced to 25°C	-	60	-	mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V	-	-	1	μΑ
I _{GSSF}	Gate – Body Leakage, Forward	V _{GS} = 20 V, V _{DS} = 0 V	-	-	100	nA
I _{GSSR}	Gate – Body Leakage, Reverse	V _{GS} = -20 V, V _{DS} = 0 V	-	-	-100	nA
On Charac	cteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$ $T_J = 125^{\circ}C$	1 0.7	1.7 -	3 2.2	V
R _{DS(on)}	Static Drain-Source On-Resistance	V_{GS} = 10 V, I_{D} = 3.5 A T_{J} = 125°C V_{GS} = 4.5 V, I_{D} = 2.5 A T_{J} = 125°C	-	0.076 0.124 0.103 0.166	0.1 0.18 0.2 0.3	Ω
I _{D(on)}	On-State Drain Current	V _{GS} = 10 V, V _{DS} = 10 V	10	-	-	Α
9FS	Forward Transconductance	V _{DS} = 10 V, I _D = 3.5 A	-	5.3	-	S
Dynamic C	Characteristics	•				
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz	-	345	_	pF
C _{oss}	Output Capacitance		-	110	-	pF
C _{rss}	Reverse Transfer Capacitance		-	25	_	pF
Switching	Characteristics (Note 2)	•				
t _{d(on)}	Turn-On Delay Time	V _{DD} = 30 V, I _D = 1 A,	-	5	25	ns
t _r	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$	-	7.5	30	ns
t _{d(off)}	Turn-Off Delay Time		-	20	50	ns
t _f	Turn-Off Fall Time		-	7	40	ns
Qg	Total Gate Change	V _{DS} = 30 V, I _D = 3.5 A,	-	12.9	30	nC
Q _{gs}	Gate-Source Change	V _{GS} = 10 V	-	1.7	-	nC
Q_{gd}	Gate-Drain Change		-	3.2	_	nC
Drain-Sou	rce Diode Characteristics and Maximum	Ratings				
I _S	Maximum Continuous Drain-Source Diode Forward Current		-	-	1.3	Α
V_{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 1.3 A (Note 2)	-	0.8	1.2	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_F = 1.3 \text{ A,}$ $d_{iF}/d_t = 100 \text{ A/}\mu\text{s}$	-	40	_	ns
I _{rr}	Reverse Recovery Current		-	1.5	-	Α

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.





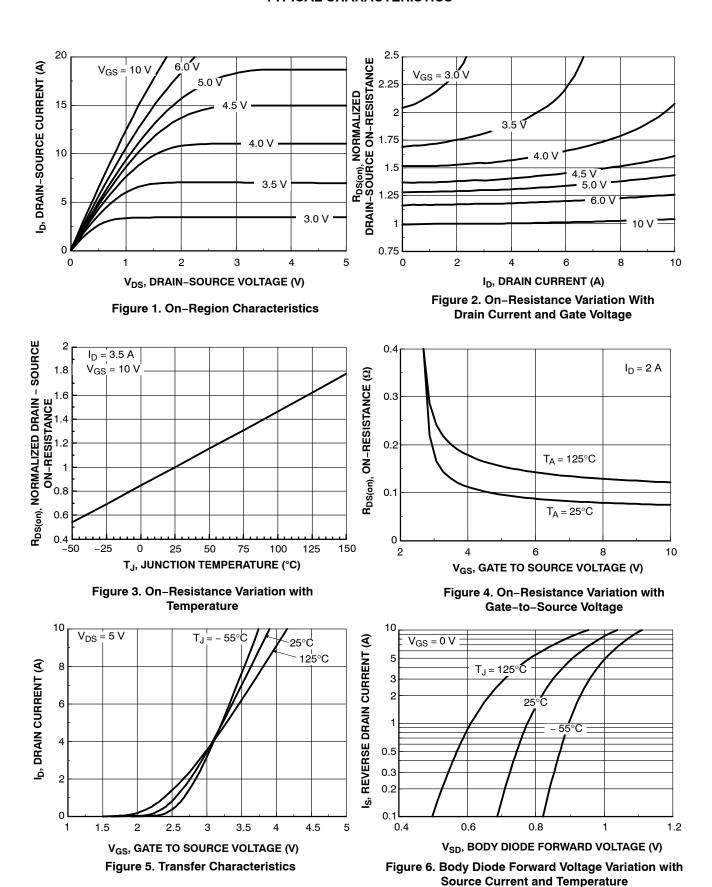


Scale 1 1 on letter size paper

2. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

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TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS (CONTINUED)

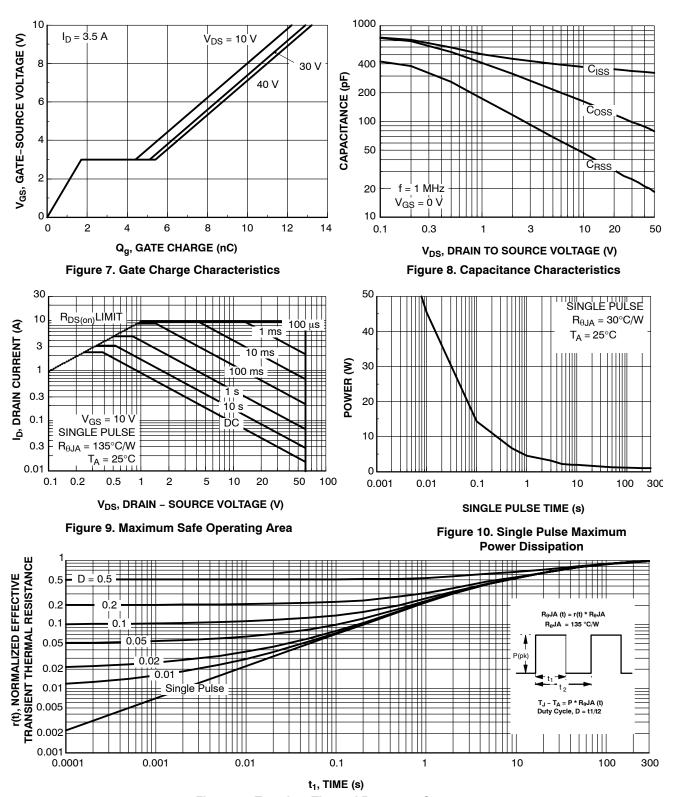
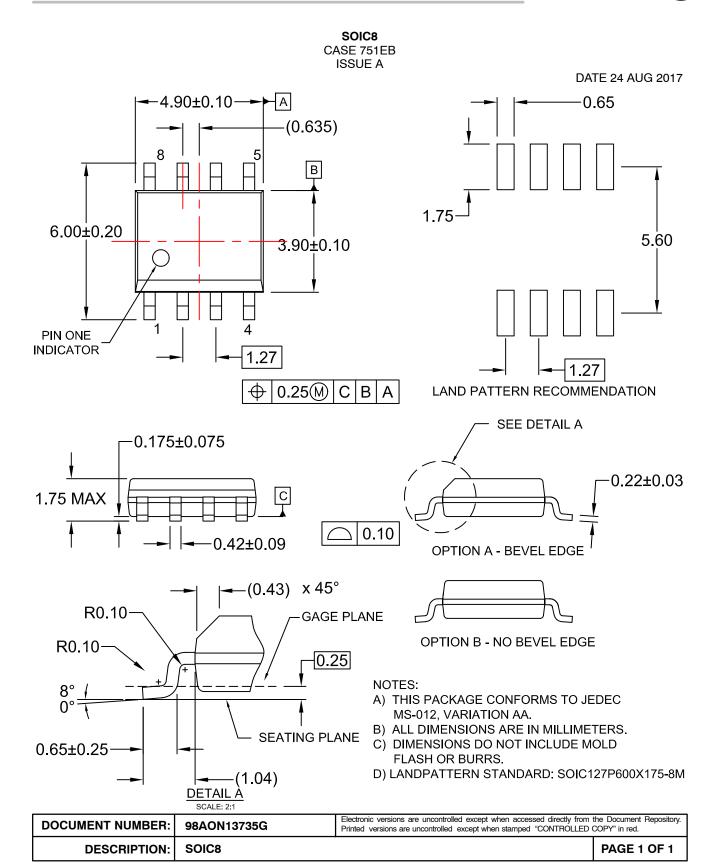


Figure 11. Transient Thermal Response Curve

Thermal characterization performed using the conditions described in Note 1a. Transient themal response will change depending on the circuit board design.



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